

TRADEMARK ASSIGNMENT

Electronic Version v1.1
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT		
NATURE OF CONVEYANCE:	SECURITY INTEREST		
CONVEYING PARTY DATA			
Name	Formerly	Execution Date	Entity Type
EKAHAU, INC.		04/03/2006	LIMITED LIABILITY COMPANY: FINLAND
RECEIVING PARTY DATA			
Name:	ETV CAPITAL S.A.		
Street Address:	c/o ETV Capital Limited - 1 Tenterden Street		
City:	London		
State/Country:	UNITED KINGDOM		
Postal Code:	W1 S1 TA		
Entity Type:	CORPORATION: LUXEMBOURG		
PROPERTY NUMBERS Total: 1			
Property Type	Number	Word Mark	
Serial Number:	78355569	EKAHAU	
CORRESPONDENCE DATA			
Fax Number:	(404)962-6836		
	<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>		
Phone:	404-885-3697		
Email:	trademarks@troutmansanders.com		
Correspondent Name:	Anne E. Yates, Esq.		
Address Line 1:	600 Peachtree Street, N.E.		
Address Line 2:	Troutman Sanders LLP - Suite 5200		
Address Line 4:	Atlanta, GEORGIA 30308-2216		
ATTORNEY DOCKET NUMBER:	36800.5		
DOMESTIC REPRESENTATIVE			
Name:	Anne E. Yates, Esq.		
Address Line 1:	600 Peachtree Street, N.E.		

OP \$40.00 78355569

Address Line 2: Troutman Sanders LLP - Suite 5200
Address Line 4: Atlanta, GEORGIA 30308-2216

NAME OF SUBMITTER:	Anne E. Yates
Signature:	/aey/
Date:	04/11/2006

Total Attachments: 6

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INTELLECTUAL PROPERTY SECURITY AGREEMENT

This Intellectual Property Security Agreement is entered into as of April 3, 2006 by and between ETV CAPITAL S.A. ("Lender") and EKAHAU, INC. ("Grantor").

RECITALS

A. Lender has agreed to make certain advances of money and to extend certain financial accommodation to Grantor (the "Loans") in the amounts and manner set forth in that certain Venture Loan and Security Agreement by and between Lender and Grantor dated April 3, 2006 (as the same may be amended, modified or supplemented from time to time, the "Loan Agreement"; capitalized terms used herein are used as defined in the Loan Agreement). Lender is willing to make the Loans to Grantor, but only upon the condition, among others, that Grantor shall grant to Lender a security interest in certain Copyrights, Trademarks and Patents to secure the obligations of Grantor under the Loan Agreement.

B. Pursuant to the terms of the Loan Agreement, Grantor has granted to Lender a security interest in all of Grantor's right, title and interest, whether presently existing or hereafter acquired, in, to and under all of the Collateral.

NOW, THEREFORE, for good and valuable consideration, receipt of which is hereby acknowledged, and intending to be legally bound, as collateral security for the prompt and complete payment when due of its obligations under the Loan Agreement, Grantor hereby represents, warrants, covenants and agrees as follows:

AGREEMENT

To secure its obligations under the Loan Agreement, Grantor grants and pledges to Lender a security interest in all of Grantor's right, title and interest in, to and under its Intellectual Property Collateral (including without limitation those Copyrights, Patents and Trademarks listed on Schedules A, B and C hereto), and including without limitation all proceeds thereof (such as, by way of example but not by way of limitation, license royalties and proceeds of infringement suits), the right to sue for past, present and future infringements, all rights corresponding thereto throughout the world and all re-issues, divisions, continuations, renewals, extensions and continuations-in-part thereof.

This security interest is granted in conjunction with the security interest granted to Lender under the Loan Agreement. The rights and remedies of Lender with respect to the security interest granted hereby are in addition to those set forth in the Loan Agreement and the other Loan Documents, and those which are now or hereafter available to Lender as a matter of law or equity. Each right, power and remedy of Lender provided for herein or in the Loan Agreement or any of the Loan Documents, or now or hereafter existing at law or in equity shall be cumulative and concurrent and shall be in addition to every right, power or remedy provided for herein and the exercise by Lender of any one or more of the rights, powers or remedies provided for in this Intellectual Property Security Agreement, the Loan Agreement or any of the other Loan Documents, or now or hereafter existing at law or in equity, shall not preclude the simultaneous or later exercise by any person, including Lender, of any or all other rights, powers or remedies.

IN WITNESS WHEREOF, the parties have caused this Intellectual Property Security Agreement to be duly executed by its officers thereunto duly authorized as of the first date written above.

Address of Grantor:

12930 Saratoga Avenue, suite B-8,
44227 Saratoga, California, 95070
Attn: MR. ANTTI KORHONEN

GRANTOR:

EKAHAU, INC.

By: *Antti Korhonen*
Title: PRESIDENT & CEO

Address of Lender:

Attn: _____

BANK:

ETV CAPITAL S.A.

By: _____

Title: _____

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IN WITNESS WHEREOF, the parties have caused this Intellectual Property Security Agreement to be duly executed by its officers thereunto duly authorized as of the first date written above.

GRANTOR:

Address of Grantor:

EKAHAU, INC.

12930 Saratoga Avenue, suite B-8,
44227 Saratoga, California, 95070

Attn: _____

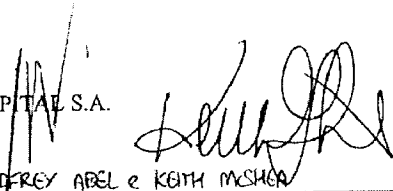
By: _____

Title: _____

Address of Lender:

BANK:

ETV CAPITAL S.A.

By:  GODFREY ABEL e KEITH MSHA

Attn: _____

Title: DIRECTORS

EKAHAU, INC./EKAHAU OY

Exhibit A - Copyrights

<u>Title</u>	<u>Registration Number</u>	<u>Registration Date</u>	<u>Owner</u>	<u>Security Interest</u>
N/A	N/A	N/A	N/A	N/A

ETV_Ekahau (IP Security Agree) (2) DOC

Exhibit B - Trademarks

<u>Mark</u>	<u>Status</u>	<u>Application Number</u>	<u>Application Date</u>	<u>Owner</u>	<u>Security Interest</u>
EKAHAU	Allowed	78/355569	01/22/2004	EKAHAU OY, a/k/a EKAHAU, INC.	None recorded

Exhibit C – Patents/Patent Applications

<u>Title</u>	<u>Patent/Patent Application Number (Publication Number)</u>	<u>Filing Date</u>	<u>Owner/Assignee</u>	<u>Security Interest</u>
Positioning Technique	11/030,334 (2005-0197139)	7 JANUARY 2005	EKAHAU OY	None recorded
Applications of signal quality observations	11/029,642 (2005-0181804)	6 JANUARY 2005	EKAHAU OY	None recorded
Sequence-based positioning technique	10/999,191 (2005-0136944)	30 NOVEMBER 2004	EKAHAU OY	None recorded
Error estimate concerning a target device's location operable to move in a wireless environment	10/999,220 (2005-0131635)	30 NOVEMBER 2004	EKAHAU OY	None recorded
Probabilistic model for a positioning technique	10/999,140 (2005-0128139)	30 NOVEMBER 2004	EKAHAU OY	None recorded
Location applications for wireless networks	10/365,621 (2004-0176108)	13 FEBRUARY 2003	EKAHAU OY	None recorded
Location estimation in wireless telecommunication networks	10/465,785 (2004-0072577)	20 JUNE 2003	EKAHAU, INC. and EKAHAU OY	None recorded

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